Stability study: thermal stress validation



Product: UMIC VANCOMYCIN/TEICOPLANIN Ref: UM-VAN/TEI-040

Objective:

Limits of storage and shipping conditions for the UMIC VANCOMYCIN/TEICOPLANIN kit were determined by thermal stress validity studies in accordance with EN ISO 23640:2015 standard.

These studies confirm that product performances are maintained until the expiration date.

These studies consist in simulation of extreme storage and shipping conditions that may occur during delivery and/or storage.

Study:

Performances of the strips of UMIC VANCOMYCIN/TEICOPLANIN kit were assessed with the quality control strains recommended by EUCAST.

Performances were assessed at regular period on product stressed by 10 days of incubation at 45°C and then stored at room temperature, until their expiry date. Strips stored at recommended conditions were used as reference.

Obtained results are compliant, in accordance with the expected MIC values.

QC strains	Expected MIC values		Dagusta
	Vancomycin	Teicoplanin	Results
- S. aureus ATCC 29213	0.5-2 μg/mL	0.25-1 μg/mL	Pass
- E. faecalis ATCC 29212	1-4 µg/mL	0.25-1 μg/mL	

Note:

This document does not authorize:

- The storage of the UMIC VANCOMYCIN/TEICOPLANIN kit at any other storage conditions than mentioned on the label and in the instructions for use (+15/+25°C in dry air),
- The use of these devices after their expiration date.

Responsable Qualité / Quality Manager

Date d'application et visa / Effective date and visa

25.05.2022

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